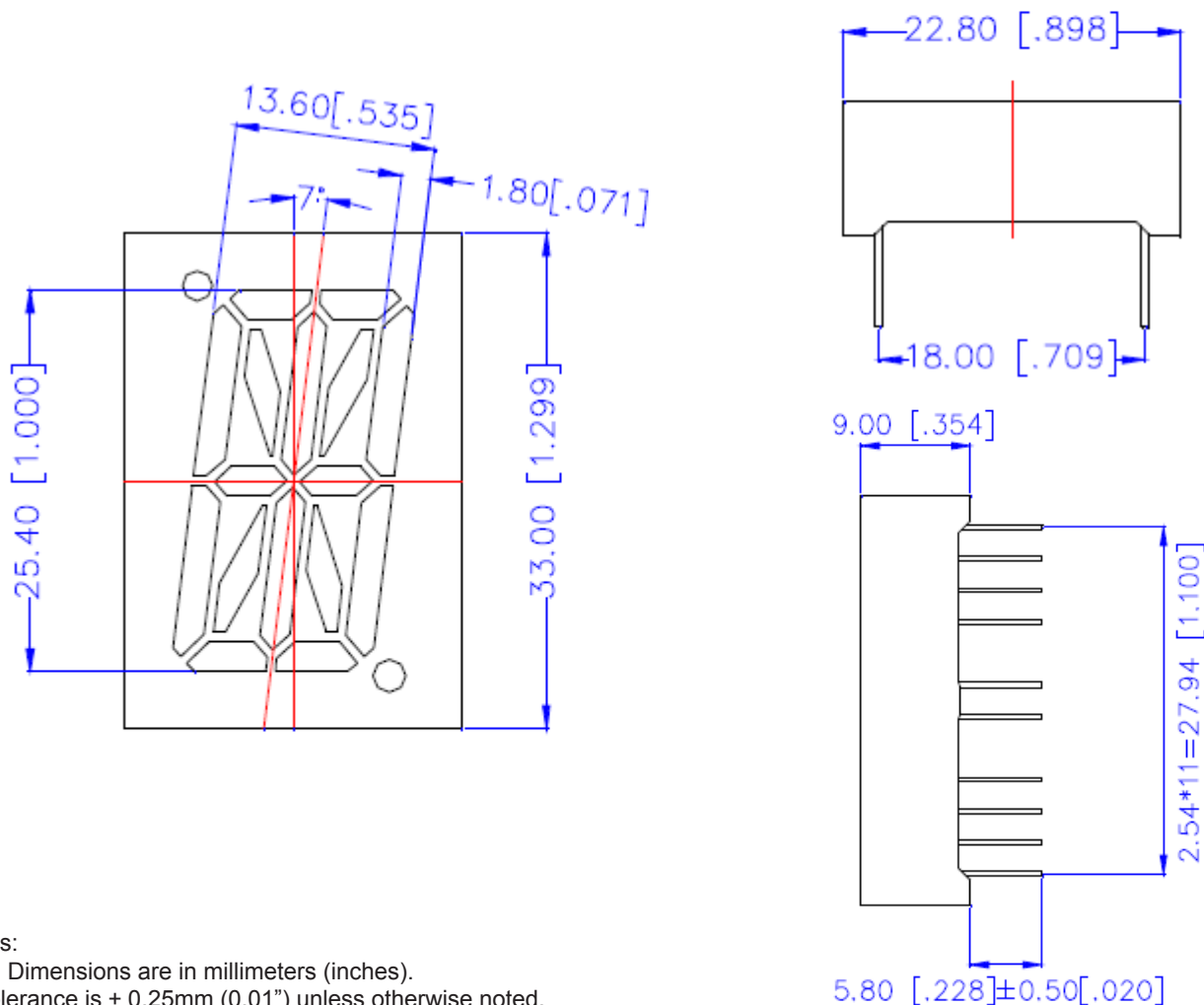


SPECIFICATIONS

CDSAN10R2WF-2DP

OUTLINES DIMENSIONS



Notes:

1. All Dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25\text{mm}$ (0.01") unless otherwise noted.
3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Description
CDSAN10R2WF-2DP	InGaAlP	Red	White Segment	Common Anode



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ABSOLUTE MAXIMUM RATINGS
(TA=25°C)

Parameter	Symbol	Max Rating	Unit
Power Dissipation	P _D	70	mW
Pulse Forward Current	I _{FP}	90	mA
Continuous Forward Current	I _F	25	mA
Reverse Voltage Segment	V _R	5	V
Operating Temperature Range	T _{OPR}	-35~+85	°C
Storage Temperature Range	T _{STG}	-35~+85	°C
I _{FP} = Pulse Width ≤ 10 ms, Duty Ratio ≤ 1/10. Soldering Condition: 260 °C/ 5sec			

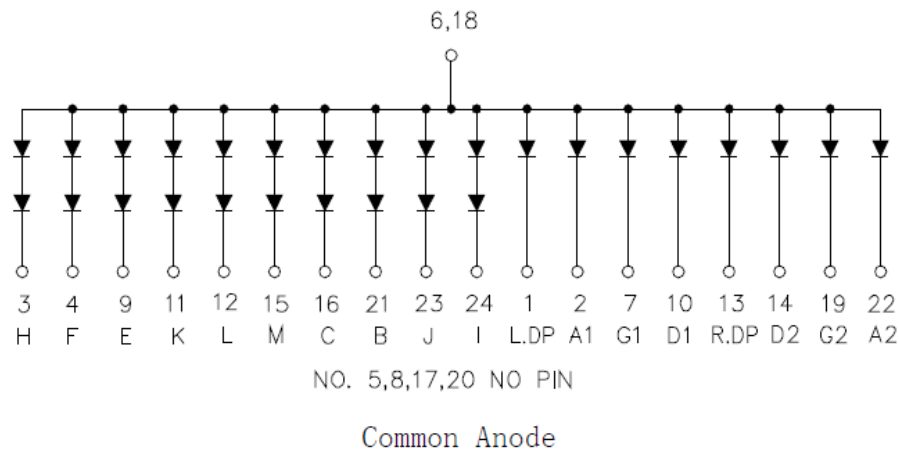
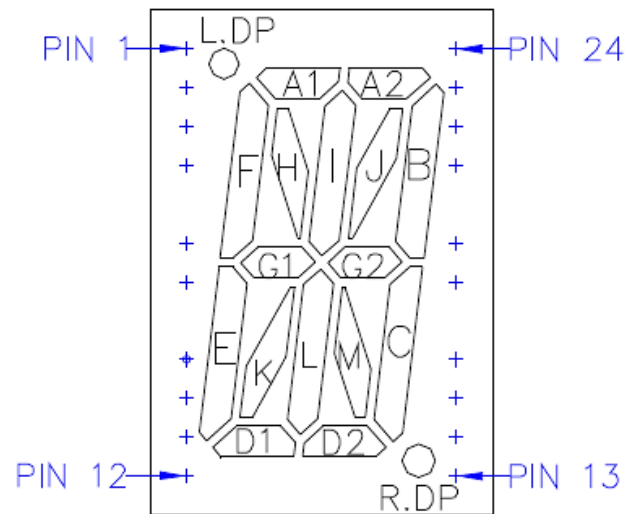
OPTICAL-ELECTRICAL CHARACTERISTICS
(TA=25°C)

Parameter	Symbol	Test Condition	Value			Unit
			Min	Typ	Max	
Luminous Intensity	I _V	I _F = 10mA	-	46	-	mcd
Forward Voltage	V _F	I _F = 20mA	-	4	5.6	V
Reverse Leakage Current	I _R	V _R = 10V	-	-	100	μA
Peak Wavelength	λ _P	I _F = 20mA	-	660	-	nm
Dominant Wavelength	λ _D	I _F = 20mA	-	645	-	nm
Spectral Radiation Bandwidth	Δλ	I _F = 20mA	-	20	-	nm



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TYPICAL INTERNAL EQUIVALENT CIRCUIT



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OPTICAL CHARACTERISTIC CURVES

(25 °C Free Air Temperature Unless Otherwise Specified)

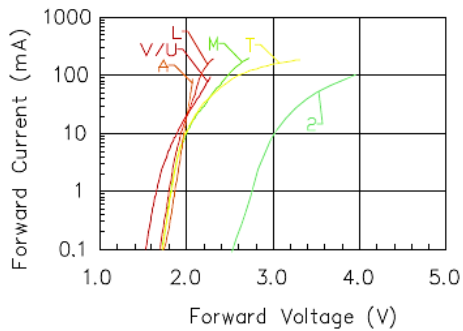


Fig 1. Forward Current vs. Forward Voltage

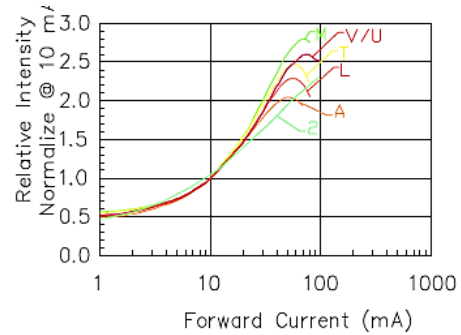


Fig 2. Relative Intensity vs. Forward Current

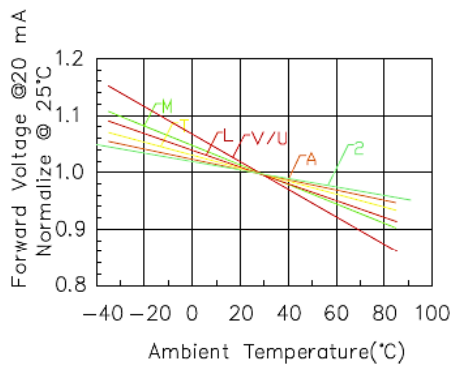


Fig 3. Forward Voltage vs. Temperature

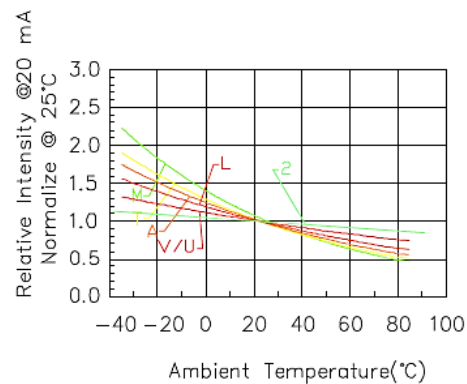


Fig 4. Relative Intensity vs. Temperature

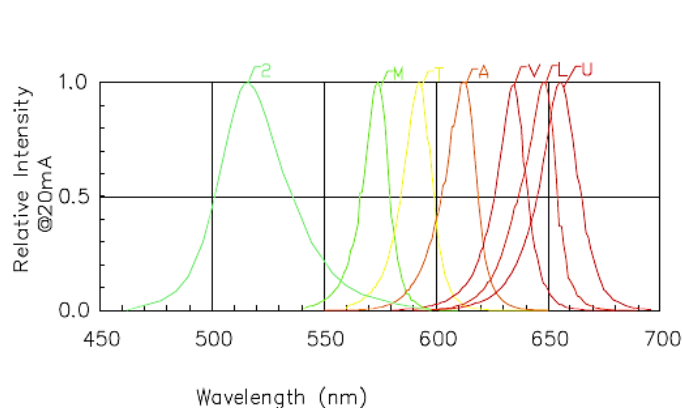


Fig 5. Relative Intensity vs. Wavelength

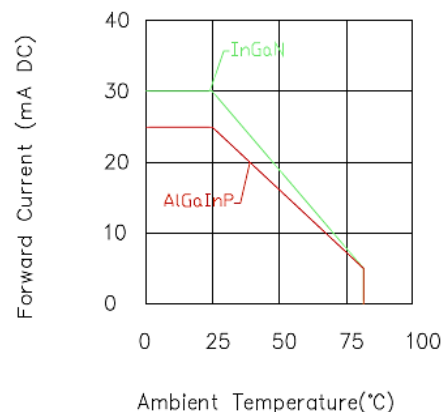


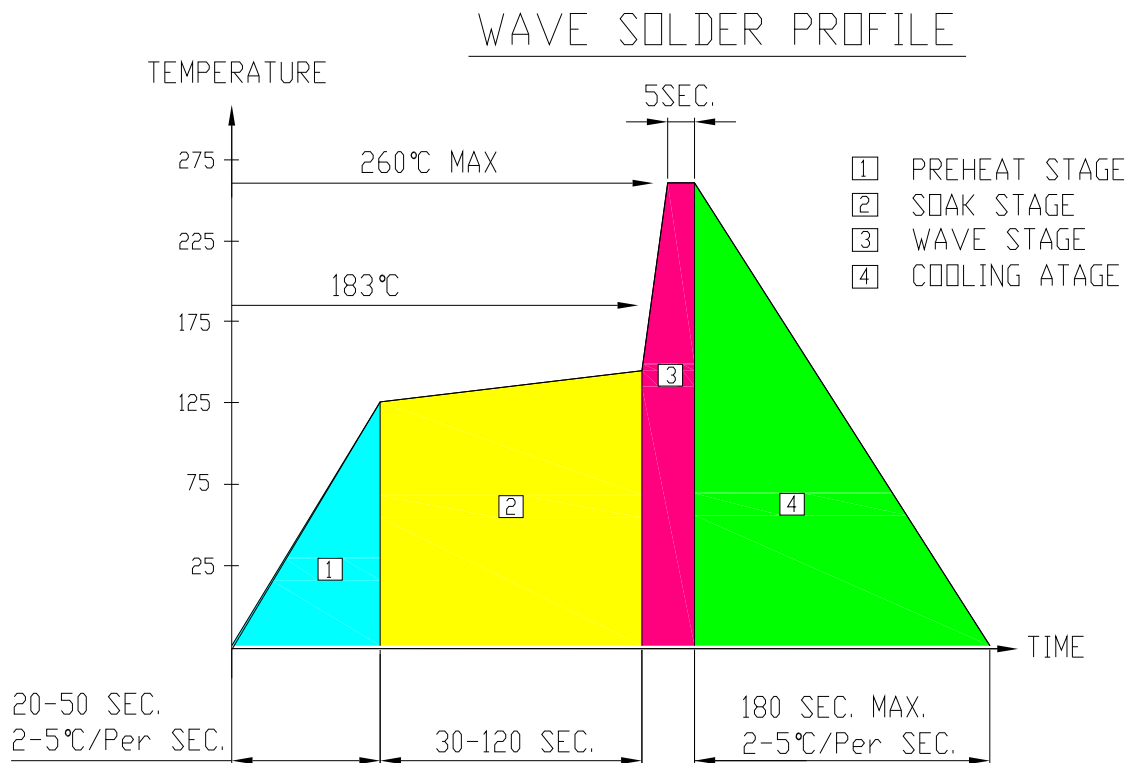
Fig 3. Forward Current vs. Ambient Temperature



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SOLDERING CONDITIONS – DISPLAY TYPE LED

● RECOMMEND SOLDERING PROFILE



● SOLDERING IRON

Basic spec is ≤ 4 sec when 260°C. If temperature is higher, time should be shorter (+10°C→1 sec). Power dissipation of Iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C.

● REWORK

Customer must finish rework within ≤ 4 sec under 245°C.



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